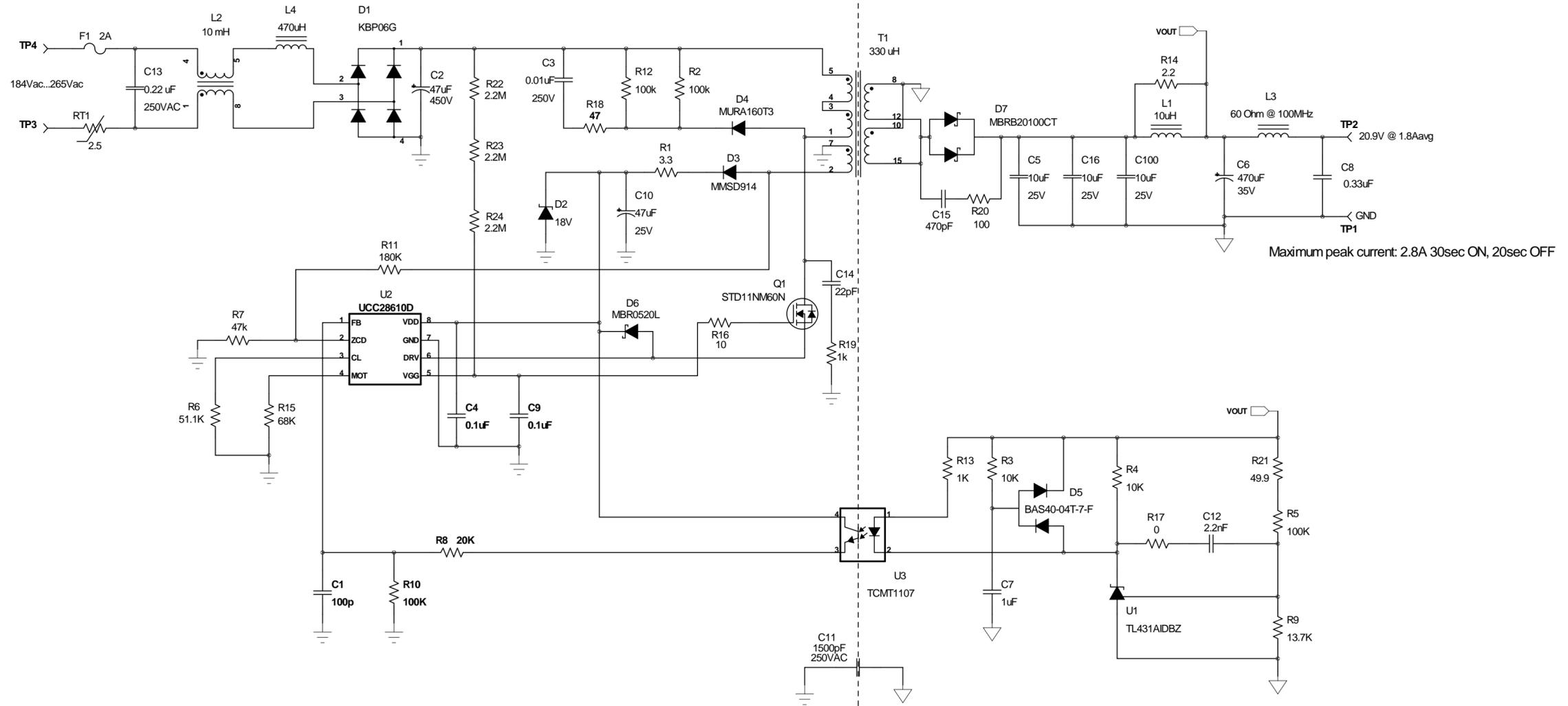


NOTES:

- 1) Built on PMP5628 Rev\_B PCB
- 2) R21 for test purpose only
- 3) Ref. des. > 99 added on the board



Maximum peak current: 2.8A 30sec ON, 20sec OFF

Title			
184V...265Vac to 20.9V @ 1.8Aavg, 2.8Apk for 30 sec.			
Size	Number	Rev	
C	PMP7030	C	
Date	10/04/2011	Drawn by	R. Scibilia
Engineer	R. Scibilia	Filename	PMP7030 Rev_A_pads.sch
		Sheet	1 of 1



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